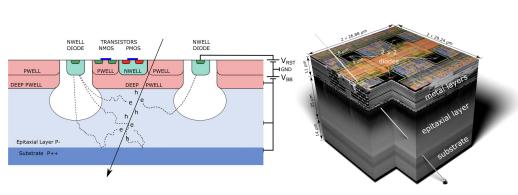
Technology development:

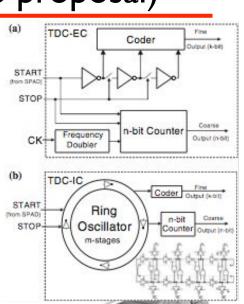
Pixel sensor with ~10 picosecond timing resolution

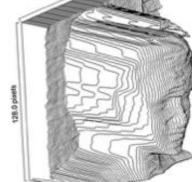
Add ~10ps timing resolution to pixel (2018 proposal)

- Keep all nice features of MAPS
 - Low radiation length, good radiation hardness
 - Commercial CMOS manufacturing process
- ~10ps timing: on the verge of possibility
 - Existing fast-timing circuitry implemented in CMOS
 - Existing fast-timing charge/light sensor in CMOS

Ref: SPAD array 3D imaging sensor





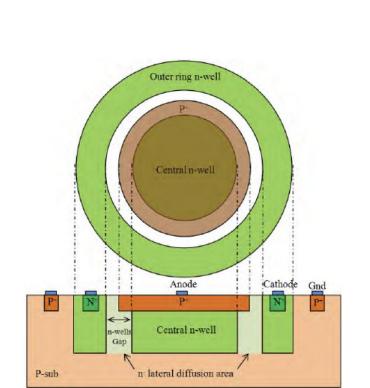


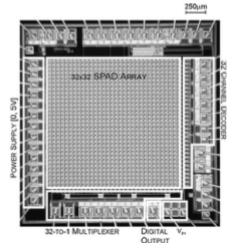
Cathode

Central n-well

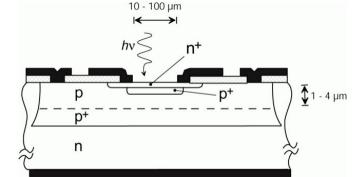
Avalanche Diode in CMOS

SPAD Single-Photon Avalanche Diode

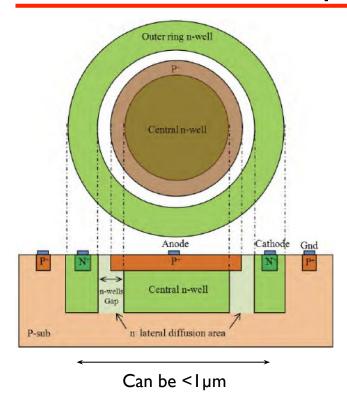


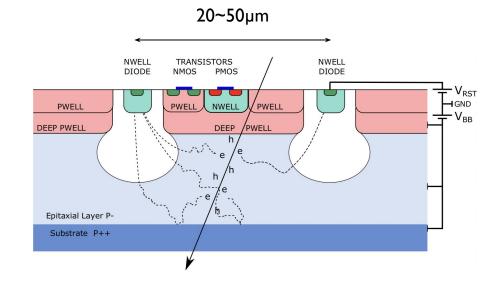


APD LGAD MPPC SiPM

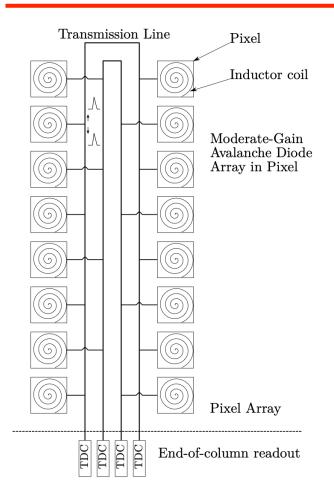


Avalanche Diode improves timing

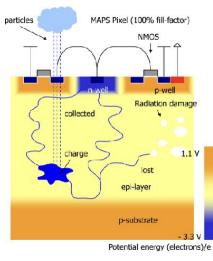


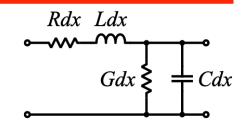


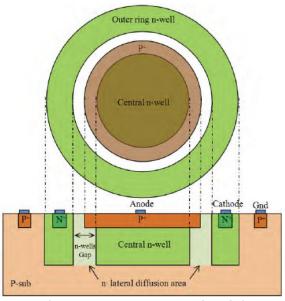
AD-TL pixel array and TDC readout (proposed for LDRD FY20)



$$u = \frac{1}{\sqrt{LC}}$$
$$Z_0 = \sqrt{\frac{L}{C}}$$







Avalanche Diode in CMOS

Recent advancement in the field

Sub-10 ps Minimum Ionizing Particle Detection with Geiger-Mode APDs

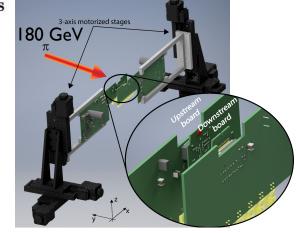
Francesco Gramuglia,^{1,*} Emanuele Ripiccini,^{1,*} Carlo Alberto Fenoglio,¹
Ming-Lo Wu,¹ Lorenzo Paolozzi,^{2,3} Claudio Bruschini,¹ and Edoardo Charbon¹

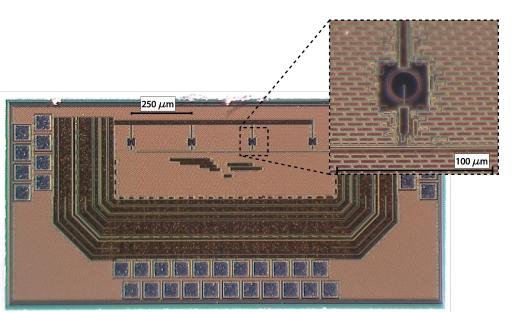
¹École polytechnique fédérale de Lausanne (EPFL)

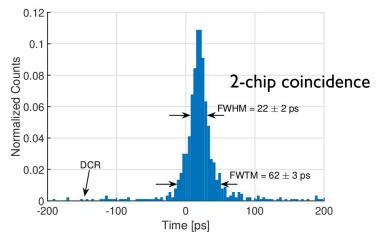
²University of Geneva

³CERN

(Dated: November 22, 2021)







Δt , Δl

~10ps, ~10µm All-silicon tracker

Support

Resources

- Physicists in the group dive into design, testing, etc. IFTE.
- Small but steady stream of money, perhaps \$50k/yr for hardware and manufacturing.
- Occasional boost with engineering resources.
- LDRD is insufficient: not timely enough and too restrictive.